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PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3345384

		N	EW ASSIGNMENT				
NATURE OF CONVEYANCE:		A	ASSIGNMENT				
CONVEYING PARTY DA	TA	•					
		Na	ime		Execution Date		
CHUN-WEI CHANG					08/31/2012		
CHIH-CHIEN WANG					08/31/2012		
WANG-PEN MO					08/31/2012		
HUNG-CHANG HSIEH				09/03/2012			
	ГА						
Name:		N SEMI	CONDUCTOR MANUF	ACTURI	NG COMPANY, LTD.		
Street Address:	NO. 8,	LI-HSIN	RD. 6				
Internal Address:			ED INDUSTRIAL PAR	К			
City:	HSIN-C	СНО					
State/Country:	TAIWA						
Postal Code:	300-77						
PROPERTY NUMBERS	Total: 1						
Property Type							
Property Type			Number				
Property Type Application Number:		1470738					
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Application Number:			37				
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> PATENT REEL: 035596 FRAME: 0356

Assignment

ASSIGNMENT

WHEREAS, we,

(1)	Chun-Wei Chang	of	No. 38, Lane 58, Yude Road, Shanhua District, Tainan City 741 Taiwan (R.O.C.)
(2)	Chih-Chien Wang	of	No. 6-5, Lane 518, Sec. 3, Jhongshan Road Changhua City, Changhua County 500 Taiwan (R.O.C.)
(3)	Wang-Pen Mo	of	No. 41, Lanzhou Street Pingtung City, Pingtung County 900 Taiwan (R.O.C.)
(4)	Hung-Chang Hsich	of	9 F, No. 72-12, Lane 531, Sec. 1, Kung-Fu Road Hsin-Chu City, Taiwan (R.O.C.)

have invented certain improvements in

A METHOD OF FORMING A PHOTORESIST LAYER

for which we have filed an application for Letters Patent of the United States of America on September 4, 2012, as U.S. Serial No. 13/602,465; and

WHEREAS, we authorize the attorney of record to update this document to include Patent Office information as deemed necessary (i.e., filing date, serial number, etc.);

WHEREAS, Taiwan Semiconductor Manufacturing Company, Ltd., ("TSMC"), No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park Hsin-Chu, Taiwan 300-77, Republic of China. is desirous of obtaining the entire right, title, and interest in, to and under the said invention and the said application in the United States of America and in any and all countries foreign thereto;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, and other good and valuable consideration, we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said TSMC, its successors, legal representatives, and assigns, the entire right, title, and interest in, to and under the said invention, and the said application, and all divisional, renewal, substitutional, and continuing applications thereof, and all Letters Patent of the United States of America which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may be filed for said invention in any country or countries foreign to the United States of America, and all extensions, renewals, and reissues thereof, and all prior patents and patent applications from which a filing priority of the above-described patent application may be obtained, including the right to collect past damages; and we hereby authorize and request the Commissioner of Patents of the United States of America, and any official of any country or countries foreign to the United States of America, whose duty it is to issue patents on

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PATENT REEL: 035596 FRAME: 0357

Assignment

Docket No.: 2012-0396 / 24061.2186 Customer No.: 000042717

applications as aforesaid, to issue all Letters Patent for said invention to the said TSMC, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that we will communicate to said TSMC, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid the said TSMC, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention in all countries.

Inventor Name:	Chun-Wei Chang					
Residence Address:	No. 38, Lane 58, Yude Road, Shat Tainan City 741, Taiwan (R.O.C.)					
Dated:5[2, 8,	<u>}</u>	Chun-Wej Chang nventor Signature				
Inventor Name:	Chih-Chien Wang					
Residence Address:	dence Address: No. 6-5, Lane 518, Sec. 3, Jhongshan Road Changhua City, Changhua County 500 Taiwan (R.O.C.)					
Dated: <u>>>12</u> . 0-	<u>3 </u>	okih - Chien Wong nventor Signature				
Inventor Name:	Wang-Pen Mo					
Residence Address:	No. 41, Lanzhou Street Pingtung City, Pingtung County 9	900, Taiwan (R.O.C.)				
Dated: 20/2 _ D?	5.3/	inventor Signature				

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Assignment Docket No.: 2012-0396/24061.2186 Customer No.: 000042717 Inventor Name: Hung-Chang Hsich Residence Address: 9 F, No. 72-12, Lane 531, Sec. 1, Kung-Fu Road Hsin-Chu City, Taiwan (R.O.C.) Dated: <u>9/2</u> >0/2 <u>Humg-Chamf</u> ASICA Inventor Signature

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RECORDED: 05/08/2015